

U.S.S.N. 10/051,906

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Applicants: Chao-Yuan Su et al.

Group Art Unit: 1756

Serial No.: 10/051,906

Examiner: J. Ruggles

Filed: 01/16/2002

In Response to Office Action  
Dated: 04/06/2004Do NOT  
Enter  
6/15/04  
JSRFor: A METHOD OF FORMING A SOLDER BALL USING A THERMALLY  
STABLE RESINOUS PROTECTIVE LAYER

Attorney Docket No.: 67,200-630

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Date: June 3/04

Kathy Dixon

REQUEST FOR RECONSIDERATIONCommissioner for Patents  
P.O. Box 1450  
Alexandria, Va 22313-1450

Dear Sir:

In response to an Office Action mailed 04/06/2004  
please consider the following remarks.